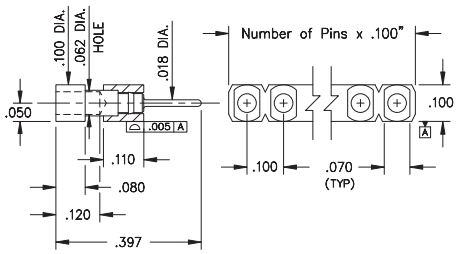
SERIES 310, 330, 351 • .100" GRID (.018" DIA. PINS), SURFACE MOUNT HEADERS AND SOCKETS • SINGLE ROW STRIPS

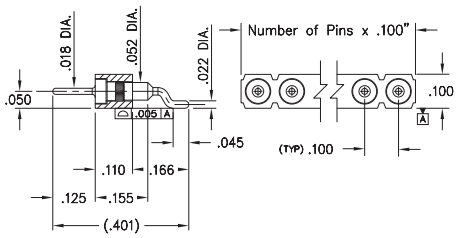
Mates with Series 310...023 Surface Mount Z-Bend Socket (See Fig. 3)



Coplanarity .005". For pin counts >10 positions, consult Technical Support.

FIG. 1

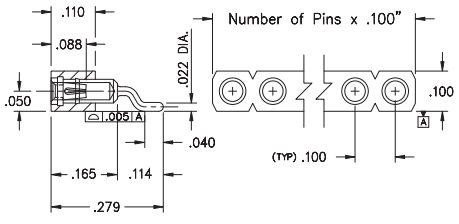
Mates with Series 310...023 Surface Mount Z-Bend Socket (See Fig. 3)



Coplanarity .005". For pin counts >10 positions, consult Technical Support.

FIG. 2

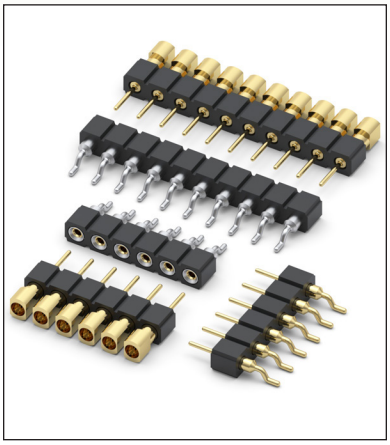
Mates with Series 351...002 and 330...027 Surface Mount Header (See Fig. 1 & 2)



Coplanarity .005". For pin counts >10 positions, consult Technical Support.

FIG. 3

- Series 351 horizontal surface mount headers are availble with .018" dia. pluggable pins (MM #5102). Series 330 horizontal surface mount z-bend headers use MM #3027 pins. See page 224 for details
- Series 310 horizontal surface mount Z-Bend sockets uses MM #1023 receptacles that accept pin diameters from .015"-.025". See pages 171 for details
- Insulators are high temperature thermoplastic, suitable for all soldering operations
- Ideal for daisy chaining parallel boards



ORDERING INFORMATION

FIG. 1 — **Series 351...002 .018" Dia. Surface Mount Header**

351-10-1__-40-002000

Specify number of pins: 02-10

FIG. 2 — **Series 330...027 .018" Dia. Surface Mount Z-Bend Header**

330-XX-1__-40-027000

Specify number of pins: 02-10

RoHS-2 2011/65/EU

XX=Plating Code See Below

For Electrical, Mechanical & Enviromental Data, See page 264

SPECIFY PLATING CODE XX=	10 ◆		40 ◆	
Pin Plating	10 µ" Au		200 µ" Sn	

FIG. 3 — **Series 310...023 .018" Dia. Surface Mount Z-Bend Socket**

310-XX-1__-40-023000

Specify number of pins: 02-10

RoHS-2 2011/65/EU

XX=Plating Code See Below

For Electrical, Mechanical & Enviromental Data, See page 264

SPECIFY PLATING CODE XX=		91	93	99	41 ◆	43 ◆	44 ◆
Sleeve (Pin)		200 µ"Sn/Pb	200 µ"Sn/Pb	200 µ"Sn/Pb	200 µ" Sn	200 µ" Sn	200 µ" Sn
Contact (Clip)		10 µ" Au	30 µ" Au	100 µ"Sn/Pb	10 µ" Au	30 µ" Au	100 µ" Sn